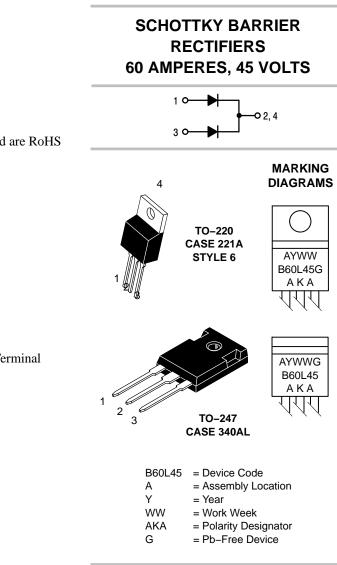
# MBR60L45CTG, MBR60L45WTG

## Switch-mode Power Rectifier 45 V, 60 A



#### **ON Semiconductor®**

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#### ORDERING INFORMATION

Device	Package	Shipping
MBR60L45CTG	TO–220 (Pb–Free)	50 Units/Rail
MBR60L45WTG	TO–247 (Pb–Free)	30 Units/Rail

#### Features and Benefits

- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capacity
- 175°C Operating Junction Temperature
- 60 A Total (30 A Per Diode Leg)
- Guard–Ring for Stress Protection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight (Approximately): 1.9 Grams (TO–220)
  - 4.3 Grams (TO-247)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube for TO-220 and 30 Units Per Plastic Tube for TO-247

#### MBR60L45CTG, MBR60L45WTG

#### MAXIMUM RATINGS (Per Diode Leg)

Rating	Symbol	Value	Unit V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45		
Average Rectified Forward Current (Rated $V_R$ ) T <sub>C</sub> = 145°C for MBR60L45CTG (Rated $V_R$ ) T <sub>C</sub> = 165°C for MBR60L45WTG	I <sub>F(AV)</sub>	30	A	
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz)	I <sub>FRM</sub>	60	A	
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	200	A	
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C	
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C	
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs	
ESD Ratings: Machine Model = C Human Body Model = 3B		> 400 > 8000	V	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

#### THERMAL CHARACTERISTICS

Characteristi	Symbol	Value	Unit	
Maximum Thermal Resistance (MBR60L45CTG) (MBR60L45WTG)	<ul> <li>Junction-to-Case</li> <li>Junction-to-Case</li> </ul>	R <sub>θJC</sub> R <sub>θJC</sub>	1.9 0.59	°C/W

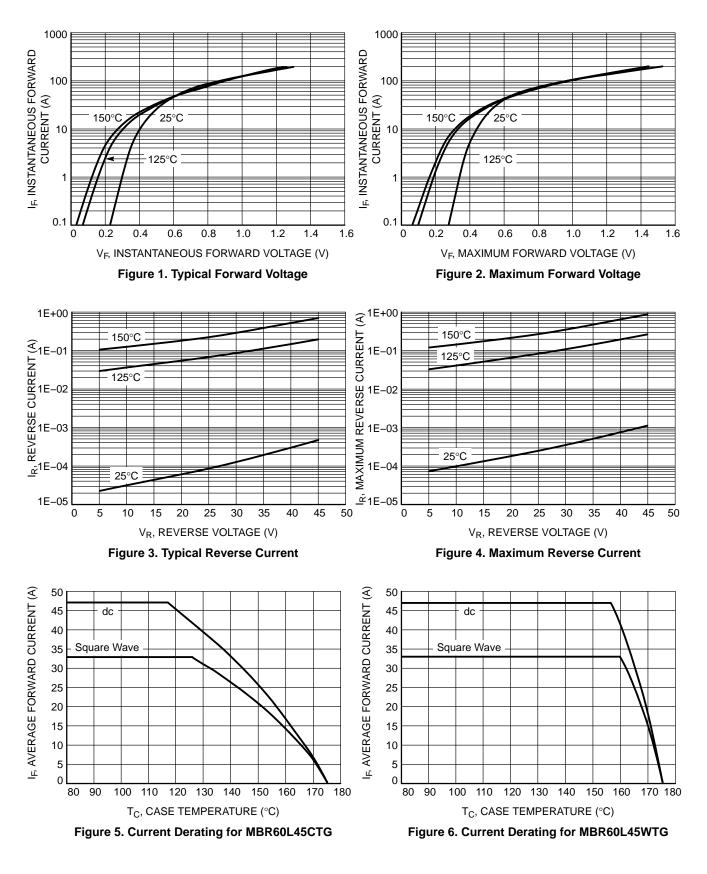
#### ELECTRICAL CHARACTERISTICS (Per Diode Leg)

Characteristic	Symbol	Value	Unit
	VF	0.55 0.53 0.73 0.76	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) (Rated DC Voltage, $T_C = 125^{\circ}C$ )	i <sub>R</sub>	1.2 275	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

#### MBR60L45CTG, MBR60L45WTG

#### **TYPICAL CHARACTERISTICS**



#### MBR60L45CTG, MBR60L45WTG

#### **TYPICAL CHARACTERISTICS**

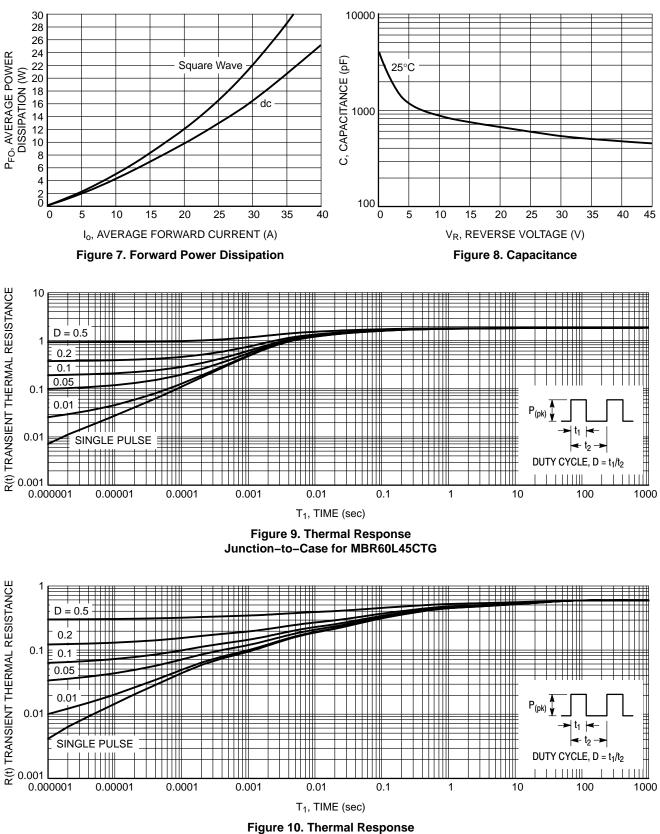


Figure 10. Thermal Response Junction-to-Case for MBR60L45WTG

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SCALE 1:1		TO-22 CASE 22 ISSUE	21A AK SEATING PLANE	2. Cont 3. dimen Leai	ROLLING D NSION Z DE D IRREGUL/	AND TOLERAI IMENSION: IN FINES A ZONI ARITIES ARE A F102 DEVICE	ICHES E WHERE AL ALLOWED.	ANSI Y14.5M	
				4. MAX V	WIDTH FOR	F102 DEVICE	= 1.3510101		
	I	Γ I			INC	HES	MILLIM	ETERS	
				DIM	MIN.	MAX.	MIN.	MAX.	
	2 3			А	0.570	0.620	14.48	15.75	
<u> </u>	┟┰┟┟╌┛──╌╂			В	0.380	0.415	9.66	10.53	
⊢	₩+₩++			С	0.160	0.190	4.07	4.83	
	í lí	f I		D	0.025	0.038	0.64	0.96	
' z –	I I K			F	0.142	0.161	3.60	4.09	
	î î			G	0.095	0.105	2.42	2.66	
				н	0.110	0.161	2.80	4.10	
	¥ ₩	ü l		J	0.014	0.024	0.36	0.61	
V —	R —			ĸ	0.500	0.562	12.70 1.15	14.27	
G	J-	╼║╼		N	0.045	0.060	4.83	1.52 5.33	
Ŭ,	' → → D			Q	0.190	0.210	2.54	3.04	
_	N -			R	0.080	0.120	2.54	2.79	
				s	0.030	0.055	1.15	1.41	
				т	0.235	0.255	5.97	6.47	
				U U	0.000	0.050	0.00	1.27	
				v	0.045		1.15		
				z		0.080		2.04	
2. 3. 4. STYLE 5: PIN 1. 2. 3. 4. STYLE 9: PIN 1. 2. 3.	BASE         PIN 1.           COLLECTOR         2.           EMITTER         3.           COLLECTOR         4.           GATE         PIN 1.           DRAIN         2.           SOURCE         3.           DRAIN         2.           GATE         PIN 1.           CALL         STYLE 10           GATE         PIN 1.           COLLECTOR         2.           EMITTER         3.	BASE EMITTER COLLECTOR EMITTER ANODE CATHODE CATHODE CATHODE	2. 3. 4. STYLE 7: PIN 1. 2. 3. 4. STYLE 11: PIN 1. 2. 3.		E E	2. MA 3. GA 4. MA STYLE 8: PIN 1. CA 2. AN 3. EX 4. AN STYLE 12: PIN 1. MA 2. MA 3. GA	IN TERMINAL THODE DDE TERNAL TRIP DDE IN TERMINAL IN TERMINAL	2 2 /DELAY .2	

 
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 TO-220
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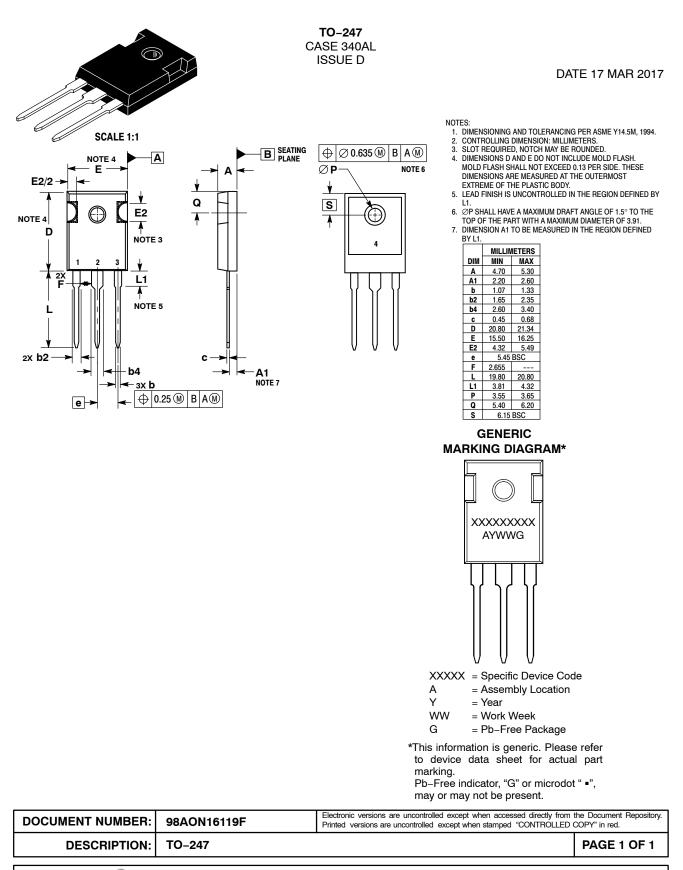
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